

N-Channel Super Junction Power MOSFET $\ {\rm IV}$

General Description

R

The series of devices use advanced trench gate super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

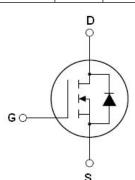
Features

- Optimized body diode reverse recovery performance
- ●Low on-resistance and low conduction losses
- Small package
- ●Ultra Low Gate Charge cause lower driving requirements
- ●100% Avalanche Tested
- ●ROHS compliant

Application

- Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- Uninterruptible Power Supply (UPS)
- LLC Half-bridge

VDS min@Tjmax 650 V RDS(ON)TYP 180 mΩ ID 18 A Qg 22.8 nC



Schematic diagram

♦ Intrinsic fast-recovery body diode

Package Marking And Ordering Information

| Device | Device Package | Marking |
|-------------|----------------|-------------|
| NCE60NF200D | TO-263 | NCE60NF200D |

Table 1. Absolute Maximum Ratings (Tc=25℃)

| Parameter | Symbol | Value | Unit |
|--|-------------------------|---------|------|
| Drain-Source Voltage (VGS=0V) | VDS | 600 | V |
| Gate-Source Voltage (VDS=0V) AC (f>1 Hz) | Vgs | ±30 | V |
| Gate-Source Voltage (VDS=0V) DC | Vgs | ±20 | V |
| Continuous Drain Current at Tc=25°C | I _{D (DC)} | 18 | A |
| Continuous Drain Current at Tc=100°C | I _{D (DC)} | 12.6 | A |
| Pulsed drain current ^(Note 1) | I _{DM (pluse)} | 54 | A |
| Maximum Power Dissipation(Tc=25°C) | PD | 150 | W |
| Derate above 25°C | | 1.0 | W/°C |
| Avalanche current ^(Note 1) | I _{AS} | 3.5 | A |
| Drain Source voltage slope, V _{DS} ≤480 V, | dv/dt | 50 | V/ns |
| Reverse diode dv/dt, V _{DS} ≤480 V,I _{SD} <i<sub>D</i<sub> | dv/dt | 50 | V/ns |
| Operating Junction and Storage Temperature Range | TJ,TSTG | -55+175 | °C |

* limited by maximum junction temperature

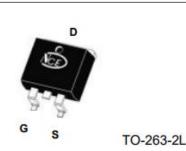




Table 2. Thermal Characteristic

| Parameter | Symbol | Value | Unit |
|---|-------------------|-------|-------|
| Thermal Resistance, Junction-to-Case (Maximum) | R _{thJC} | 1.0 | °C /W |
| Thermal Resistance, Junction-to-Ambient (Maximum) | R _{thJA} | 62 | °C /W |

Table 3. Electrical Characteristics (TA=25°C unless otherwise noted)

| Parameter | Symbol | Condition | Min | Тур | Max | Unit |
|---|---------------------|---|-----|------|------|------|
| On/off states | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | V _{GS} =0V I _D =250µA | 600 | | | V |
| Zero Gate Voltage Drain Current(Tc=25 °C) | I _{DSS} | V _{DS} =600V,V _{GS} =0V | | | 10 | μA |
| Zero Gate Voltage Drain Current(Tc=125℃) | I _{DSS} | V _{DS} =600V,V _{GS} =0V | | | 300 | μA |
| Gate-Body Leakage Current | I _{GSS} | V_{GS} =±20V, V_{DS} =0V | | | ±200 | nA |
| Gate Threshold Voltage | V _{GS(th)} | V _{DS} =V _{GS} ,I _D =250µA | 3.5 | 4.2 | 5.0 | V |
| Drain-Source On-State Resistance | R _{DS(ON)} | V _{GS} =10V, I _D =9A | | 180 | 200 | mΩ |
| Dynamic Characteristics | | | | | | |
| Input Capacitance | Clss | | | 1157 | | pF |
| Output Capacitance | Coss | V _{DS} =50V,V _{GS} =0V, F=1.0MHz | | 60 | | pF |
| Reverse Transfer Capacitance | C _{rss} | | | 1.5 | | pF |
| Total Gate Charge | Qg | | | 22.8 | | nC |
| Gate-Source Charge | Qgs | V _{DS} =400V,I _D =9A, | | 9.1 | | nC |
| Gate-Drain Charge | Q _{gd} | V _{GS} =10V | | 6 | | nC |
| Gate plateau voltage | Vgp | | | 6.5 | | V |
| Intrinsic gate resistance | Rg | f = 1 MHz open drain | | 20 | | Ω |
| Switching times | L. | | | | | |
| Turn-on Delay Time | t _{d(on)} | | | 25 | | nS |
| Turn-on Rise Time | tr | V _{DD} =380V,I _D =9A, | | 16 | | nS |
| Turn-Off Delay Time | t _{d(off)} | $R_G=1.7\Omega, V_{GS}=10V$ | | 75 | | nS |
| Turn-Off Fall Time | t _f | | | 9 | | nS |
| Source- Drain Diode Characteristics | | | | | | |
| Source-drain current(Body Diode) | I _{SD} | T OF O | | | 18 | Α |
| Pulsed Source-drain current(Body Diode) | I _{SDM} | T _c =25°C | | | 54 | А |
| Forward On Voltage | V _{SD} | Tj=25°C,I _{SD} =18A,V _{GS} =0V | | 1.0 | 1.2 | V |
| Reverse Recovery Time | t _{rr} | | | 90 | | nS |
| Reverse Recovery Charge | Qrr | Tj=25°C,I _F =9A, | | 0.32 | | uC |
| Peak Reverse Recovery Current | Irrm | di/dt=100A/µs | | 7 | | А |

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature

2. Tj=25°C,VDD=50V,VG=10V, R_G=25 Ω



TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)

Figure1. Safe operating area

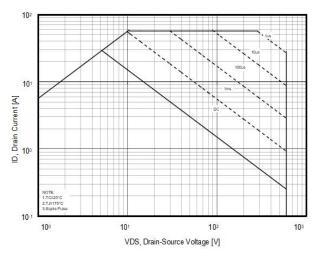


Figure3. Transfer characteristics

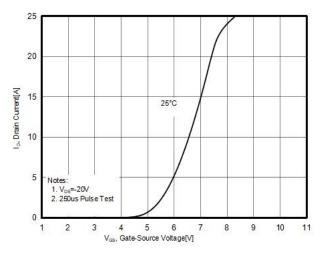


Figure 5. RDS(ON) vs Junction Temperature

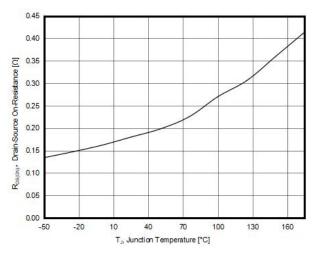


Figure2. Capacitance

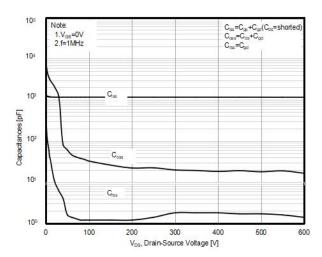


Figure4. Output characteristics

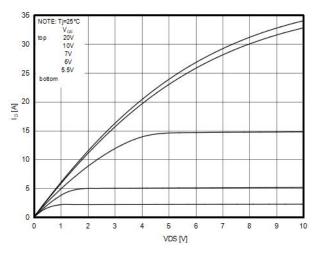


Figure6. BV_{DSS} vs Junction Temperature

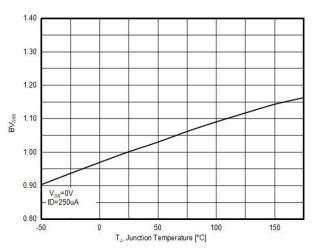




Figure 7. Maximum I_D vs Junction Temperature

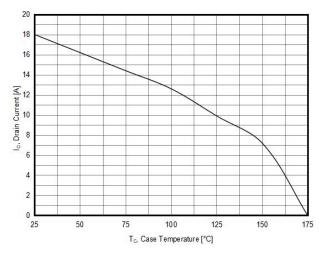


Figure8. Gate charge waveforms

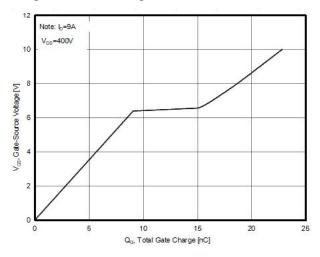


Figure9. Static drain-source on resistance

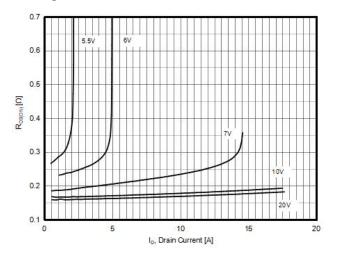
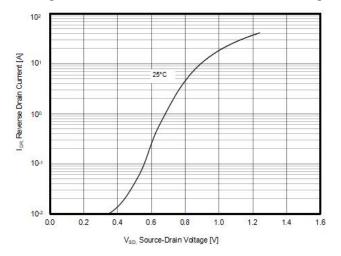


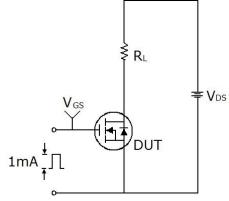
Figure10. Source-Drain Diode Forward Voltage

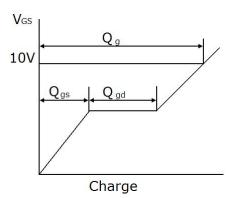




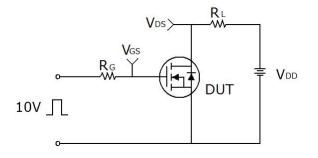
Test circuit

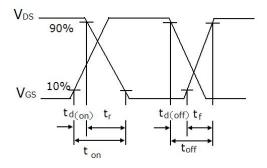
1) Gate charge test circuit & Waveform



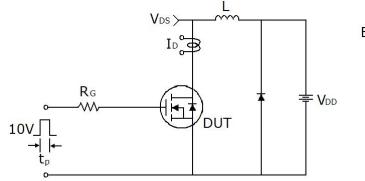


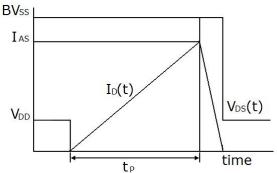
2) Switch Time Test Circuit:





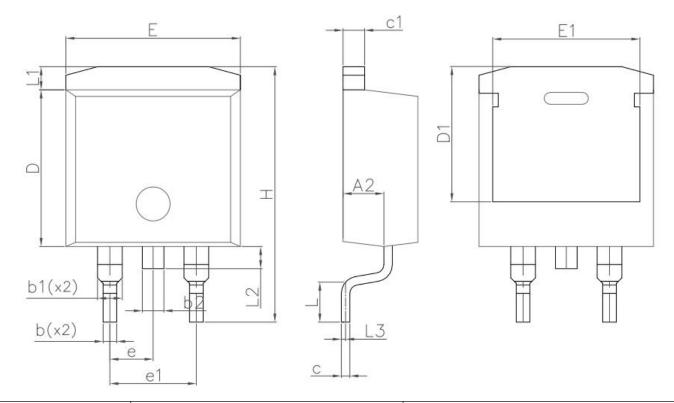
3) Unclamped Inductive Switching Test Circuit & Waveforms







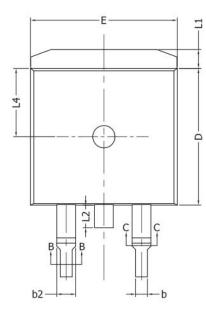
TO-263-2L-E Package Information

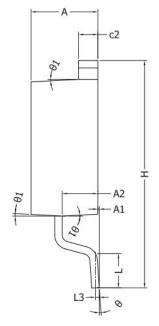


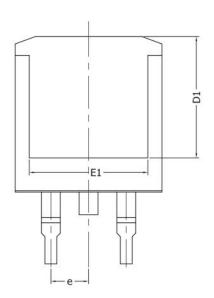
| Querry hash | Dimensions | n Millimeters | Dimensions In Inches | | |
|-------------|------------|---------------|----------------------|----------|--|
| Symbol | Min. | Max. | Min. | Max. | |
| A2 | 4.20 | 4.60 | 0.165 | 0.181 | |
| b | 0.70 | 0.90 | 0.028 | 0.035 | |
| b1 | 1.20 | 1.75 | 0.047 | 0.069 | |
| b2 | 1.17 | 1.37 | 0.046 | 0.054 | |
| с | 0.40 | 0.60 | 0.016 | 0.024 | |
| c1 | 1.15 | 1.40 | 0.045 | 0.055 | |
| D | 9.10 | 9.30 | 0.358 | 0.366 | |
| D1 | 7.63 | 8.23 | 0.300 | 0.324 | |
| E | 10.05 | 10.45 | 0.396 | 0.411 | |
| E1 | 8.35 | 8.95 | 0.329 | 0.352 | |
| е | 2.54 | BSC | 0.100 | BSC | |
| e1 | 5.08BSC | | 0.200 | BSC | |
| Н | 14.61 | 15.88 | 0.575 | 0.625 | |
| L | 1.78 | 2.79 | 0.070 | 0.110 | |
| L1 | 1.36REF | | 0.054 | 0.054REF | |
| L2 | 1.30 | REF | 0.051REF | | |



TO-263-2L-P Package Information







| Symbol | Dimensions | In Millimeters | Dimensions In Inches | |
|--------|------------|----------------|----------------------|-------|
| | Min. | Max. | Min. | Max. |
| А | 4.40 | 4.60 | 0.173 | 0.181 |
| A1 | 0.00 | 0.25 | 0.000 | 0.010 |
| A2 | 2.20 | 2.60 | 0.087 | 0.102 |
| b | 0.76 | 0.89 | 0.030 | 0.035 |
| b1 | 0.75 | 0.85 | 0.030 | 0.033 |
| b2 | 1.23 | 1.37 | 0.048 | 0.054 |
| b3 | 1.22 | 1.32 | 0.048 | 0.052 |
| С | 0.47 | 0.60 | 0.019 | 0.024 |
| c1 | 0.46 | 0.56 | 0.018 | 0.022 |
| c2 | 1.25 | 1.35 | 0.049 | 0.053 |
| D | 9.10 | 9.30 | 0.358 | 0.366 |
| D1 | 8.00 | | 0.315 | |
| E | 9.80 | 10.00 | 0.386 | 0.394 |
| E1 | 7.80 | | 0.307 | |
| е | 2.54 | 4BSC | 0.100 | BSC |
| Н | 14.90 | 15.70 | 0.587 | 0.618 |
| L | 2.00 | 2.60 | 0.079 | 0.102 |
| L1 | 1.17 | 1.40 | 0.046 | 0.055 |
| L2 | | 1.75 | | 0.069 |
| L3 | 0.25BSC | | 0.101BSC | |
| L4 | 4.6 | OREF | 0.181 | IREF |



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